

Surface Mount RF Transformer

TC1-1-13M

50Ω

4.5 to 3000 MHz

Maximum Ratings

Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

Pin Connections

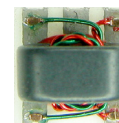
PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	1
SECONDARY	3
NOT USED	2

Features

- wideband, 4.5 to 3000 MHz
- balanced transmission line
- leadless surface mount
- good return loss
- excellent amplitude unbalance, 0.5 dB typ. and phase unbalance, 2 deg typ. in 1 dB bandwidth
- aqueous washable

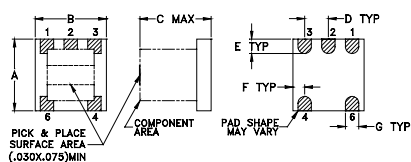
Applications

- balanced to unbalanced transformation
- push-pull amplifiers
- PCS/DCS
- MMDS

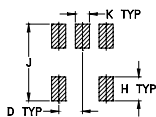


CASE STYLE: AT224 (1)
PRICE: Contact Sales Dept.
(1) NON-RoHS: TIN-LEAD PLATING (RoHS5)

Outline Drawing AT224



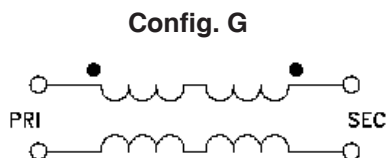
PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

Outline Dimensions (inch/mm)

A	B	C	D	E	F
.150	.150	.150	.050	.030	.025
3.81	3.81	3.81	1.27	0.76	0.64
G	H	J	K	wt	
.028	.065	.190	.030	grams	
0.71	1.65	4.83	0.76	0.10	



Transformer Electrical Specifications (T_{AMB}=25°C)

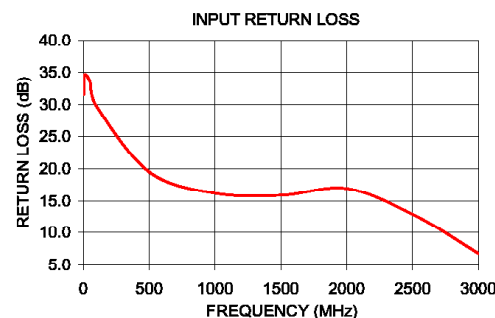
Ω RATIO	FREQUENCY (MHz)	INSERTION LOSS*			PHASE UNBALANCE (Deg.) Typ.		AMPLITUDE UNBALANCE (dB) Typ.	
		3 dB MHz	2 dB MHz	1 dB MHz	1 dB bandwidth	2 dB bandwidth	1 dB bandwidth	2 dB bandwidth
1	4.5-3000	2000-3000	1000-2000	4.5-1000	2	3	0.5	0.5

*Insertion Loss is referenced to mid-band loss, 0.5 dB typ.

NON-CATALOG

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (Deg.)
4.50	0.18	31.52	0.69	3.81
10.00	0.18	34.60	0.56	1.78
50.00	0.19	33.50	0.56	0.11
100.00	0.24	29.68	0.55	0.19
500.00	0.46	19.52	0.45	0.81
1000.00	0.68	16.22	0.14	1.59
1500.00	0.90	15.89	0.29	0.89
2000.00	1.11	16.97	0.71	1.28
2500.00	1.62	12.88	0.78	5.79
3000.00	3.02	6.79	0.49	12.32



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P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 The Design Engineers Search Engine www.minicircuits.com Provides ACTUAL Data Instantly at minicircuits.com

Notes: 1. Performance and quality attributes and conditions not expressly stated in this specification sheet are intended to be excluded and do not form a part of this specification sheet. 2. Electrical specifications and performance data contained herein are based on Mini-Circuit's applicable established test performance criteria and measurement instructions. 3. The parts covered by this specification sheet are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp.

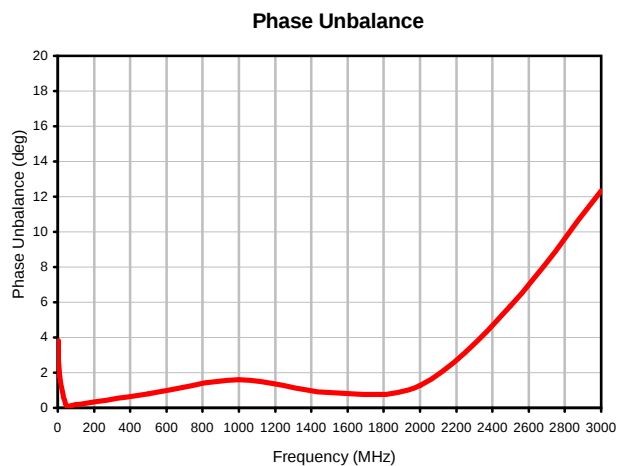
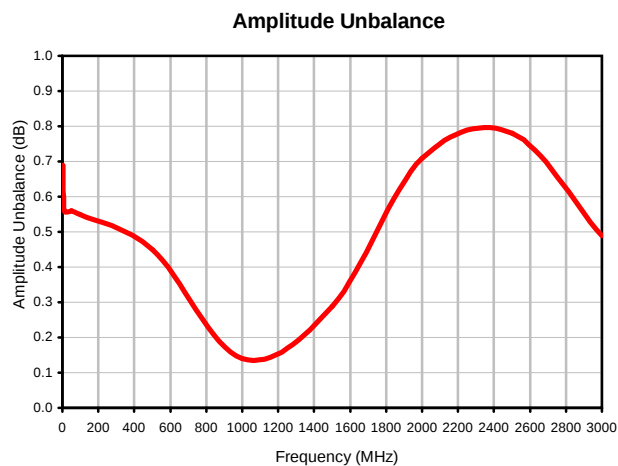
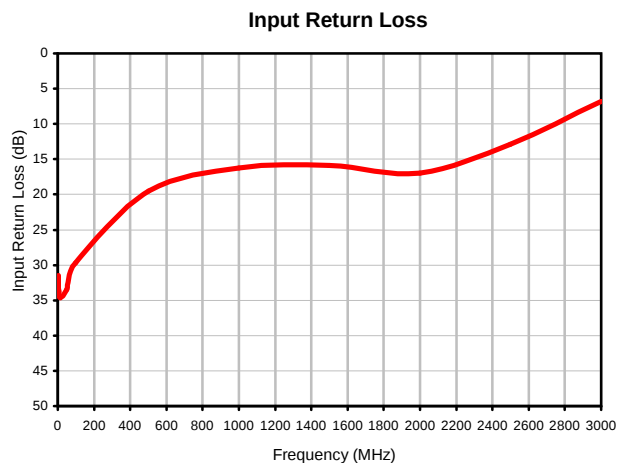
For detailed performance specs
& shipping online see web site

REV. D
M166249
TC1-1-13M
ED-11376/1
WP/TD/CP/AM
180220

Typical Performance Data

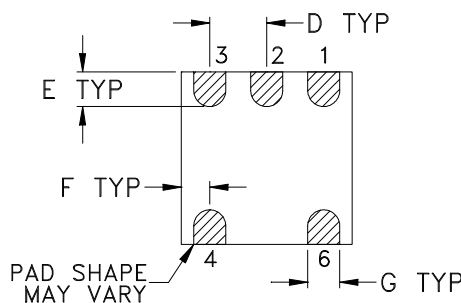
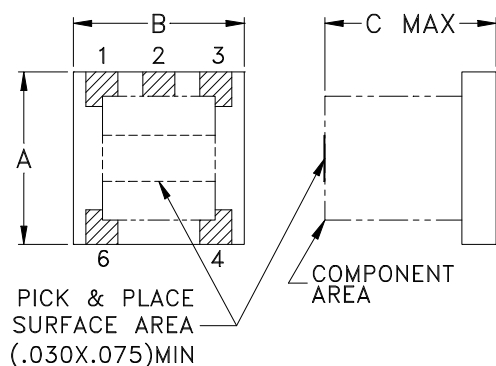
FREQUENCY (MHz)	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg)
4.5	0.18	31.52	0.69	3.81
10.0	0.18	34.60	0.56	1.78
50.0	0.19	33.50	0.56	0.11
100.0	0.24	29.68	0.55	0.19
500.0	0.46	19.52	0.45	0.81
1000.0	0.68	16.22	0.14	1.59
1500.0	0.90	15.89	0.29	0.89
2000.0	1.11	16.97	0.71	1.28
2500.0	1.62	12.88	0.78	5.79
3000.0	3.02	6.79	0.49	12.32

Typical Performance Curves

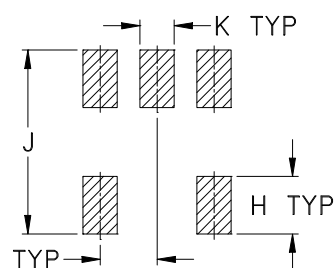


Outline Dimensions

AT224



PCB Land Pattern



Suggested Layout,
Tolerance to be within ± 0.002

CASE #	A	B	C	D	E	F	G	H	J	K	L	WT. GRAMS
AT224	.150 (3.81)	.150 (3.81)	.150 (3.81)	.050 (1.27)	.030 (0.76)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	-- --	.10

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish:
For RoHS Case Styles: 2-10 μ inch (.05-.25 microns) Gold over 100-300 μ inch (2.54-7.62 microns) Nickel plate.
All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



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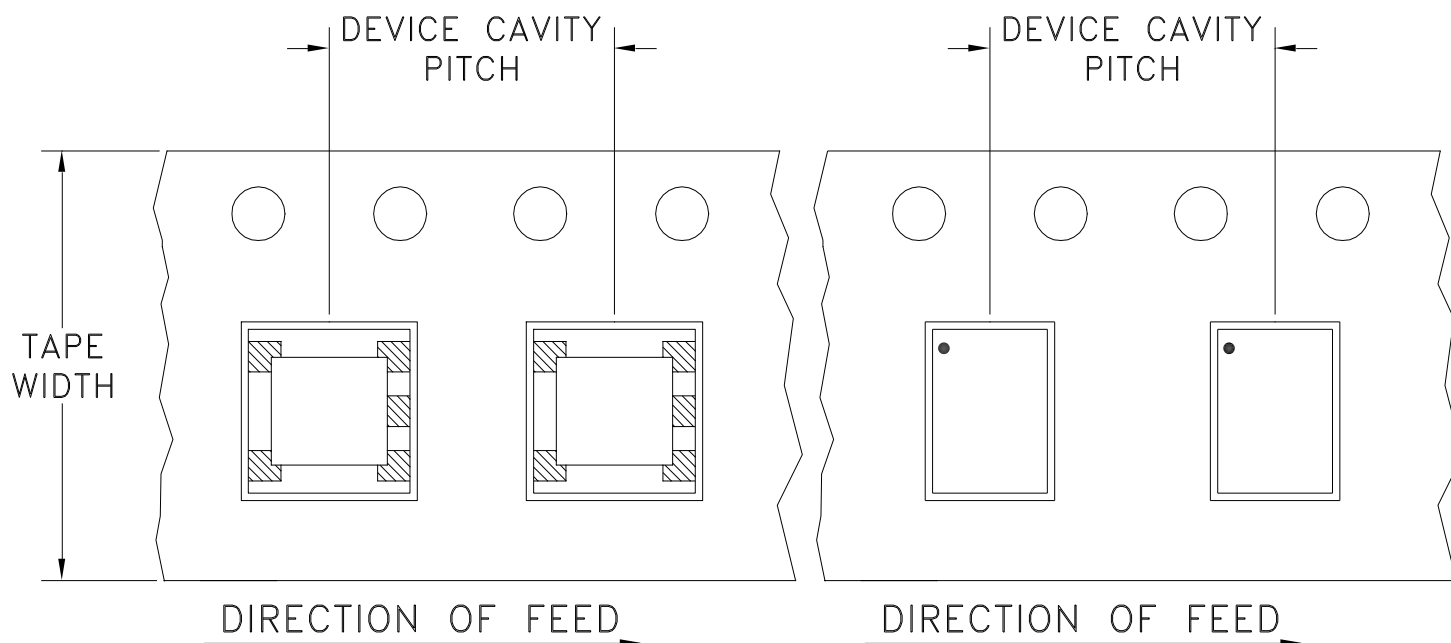


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RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
		13	Standard	1000
				2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



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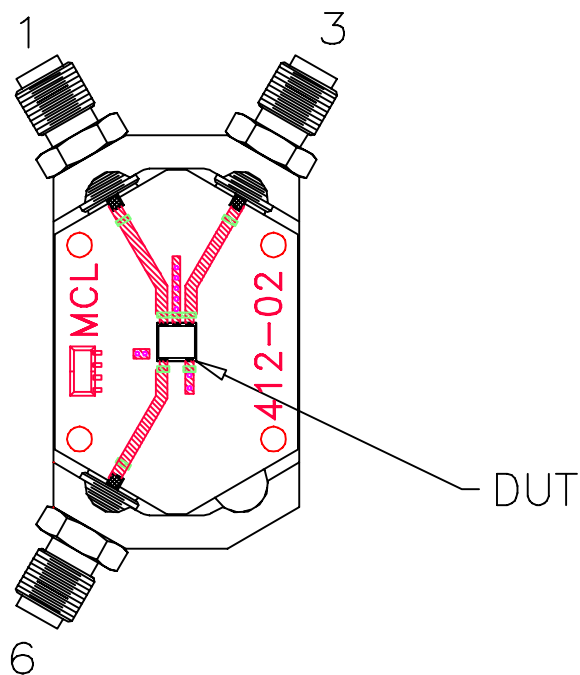


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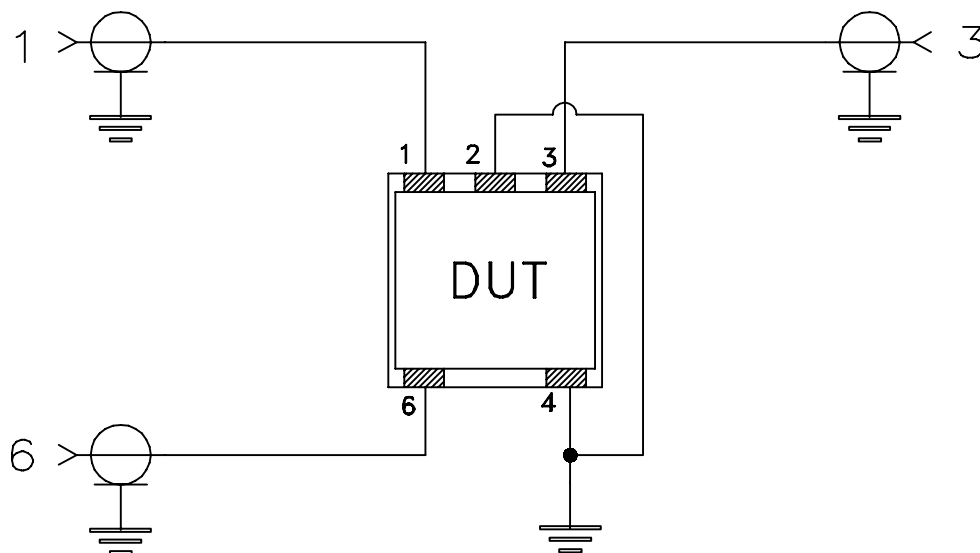
RF/IF MICROWAVE COMPONENTS

Evaluation Board and Circuit

For Pin Connections refer to Data Sheet of the DUT



TB-145



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: Rogers R04350B or its equivalent, Dielectric Constant=3.5, Thickness=.020"

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215